Docket No. 2233.002

Declaration and Power of Attorney For Patent Application

English Language Declaration

	t 1 l l d l dh	-1.	
As a below named inven	tor, I hereby declare tha	at:	
My residence, post office	e address and citizensh	ip are as stated below next to m	y name,
first and joint inventor (if which a patent is sought	plural names are listed on the invention entitle	r (if only one name is listed below I below) of the subject matter wh d D METHODS AND INFRASTRUCT	nich is claimed and for
the specification of which	1		
(check one)			
☐ is attached hereto.			
■ Was filed on Septem	ber 9, 2003	as United States Application No.	or PCT International
Application Number	10/658,123		
and was amended or	n		
		(if applicable)	
I hereby state that I have including the claims, as		tand the contents of the above idment referred to above.	dentified specification,
1.56, including for conf	tinuation-in-part application a	which is material to patentability ations, material information whand the national or PCT internation.	ich became available
application(s) for patent application which design below and have also it	r, or plant breeder's rig nated at least one cou dentified below, by ch der's rights certificate(s	35 U.S.C. 119(a)-(d) or (f), or the phase certificate(s), or 365(a) of suntry other than the United Stanecking the box, any foreign and the phase control of	any PCT International tes of America, listed application for patent,
Prior Foreign Application	n(s)		Priority Not Claimed
(Number)	(Country)	(Day/Month/Year Filed)	
(Trainion)			
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
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I hereby claim the benefit under application(s) listed below:	35 U.S.C. Section 119(e)	of any United States provisiona
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
Section 365(c) of any PCT Internat insofar as the subject matter of ea United States or PCT International	ional application designating ach of the claims of this app application in the manner p	the United States, listed below and dication is not disclosed in the prio rovided by the first paragraph of 3
Section 365(c) of any PCT Internat insofar as the subject matter of ea United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me	ional application designating ach of the claims of this application in the manner pet the duty to disclose to the eto be material to patentable between the filing date of	any United States application(s), o the United States, listed below and dication is not disclosed in the priour rovided by the first paragraph of 35 United States Patent and Trademark lity as defined in Title 37, C. F. R. the prior application and the national
Section 365(c) of any PCT Internat insofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became availab	ional application designating ach of the claims of this application in the manner pet the duty to disclose to the eto be material to patentable between the filing date of	the United States, listed below and collication is not disclosed in the priorovided by the first paragraph of 3 United States Patent and Trademar lity as defined in Title 37, C. F. R
Section 365(c) of any PCT Internatinsofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me Section 1.56 which became availab or PCT International filing date of this	ional application designating ach of the claims of this application in the manner per the duty to disclose to the entry to be material to patentable between the filing date of its application:	the United States, listed below and olication is not disclosed in the priorovided by the first paragraph of 3 United States Patent and Trademark lity as defined in Title 37, C. F. R. the prior application and the national (Status)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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